

#### 1.0 Introduction

The AMIS-30521 is a micro-stepping stepper motor driver for bipolar stepper motors. The chip is connected through I/O pins and an SPI interface with an external microcontroller. The AMIS-30521 contains a current-translation table and takes the next micro-step depending on the clock signal on the "NXT" input pin and the status of the "DIR" (=direction) register or input pin. The chip provides a so-called "speed and load angle" output. This allows the creation of stall detection algorithms and control loops based on load-angle to adjust torque and speed. It is using a proprietary PWM algorithm for reliable current control.

The AMIS-30521 is implemented in I2T100 technology, enabling both high-voltage analog circuitry and digital functionality on the same chip. The chip is fully compatible with the automotive voltage requirements.

The AMIS-30521 is ideally suited for general-purpose stepper motor applications in the automotive, industrial, medical, and marine environment.

### 2.0 Key Features

- Dual H-Bridge for 2-phase stepper motors
- Programmable peak-current up to 1.6A using a 5-bit current DAC
- · On-chip current translator
- SPI interface
- · Speed and load angle output
- · Seven step modes from full-step up to 32 micro-steps
- Fully integrated current-sense
- PWM current control with automatic selection of fast and slow decay
- Low EMC PWM with selectable voltage slopes
- · Active fly-back diodes
- Full output protection and diagnosis
- Thermal warning and shutdown
- Compatible with 5V and 3.3V microcontrollers

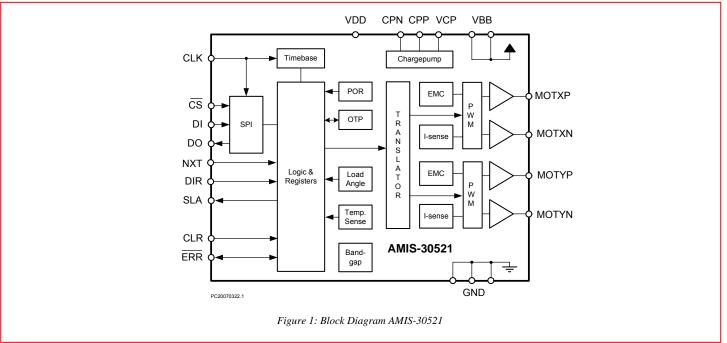
### **3.0 Ordering information**

Table 1: Ordering Information

| Part No.       | Package           | Peak Current | Temp. Range | Ordering Code<br>Tubes | Ordering Code<br>Tapes |
|----------------|-------------------|--------------|-------------|------------------------|------------------------|
| AMIS-30521 ANA | NQFP-32 (7 x 7mm) | 1600mA       | -40°C125°C  | 0C521-001-XTD          | 0C521-001-XTP          |

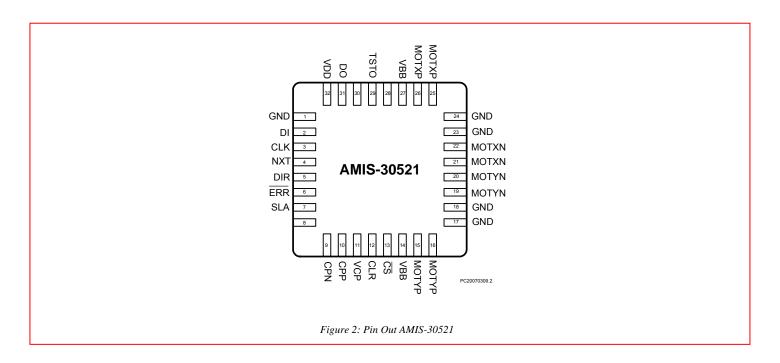


### 4.0 Block Diagram



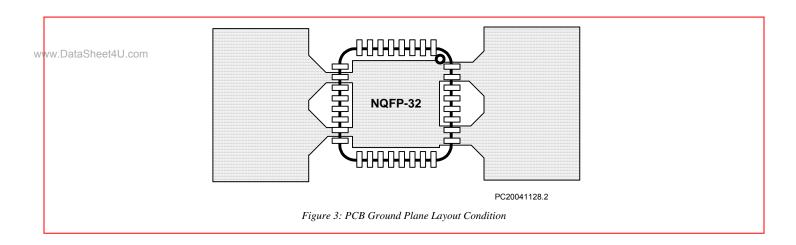
**5.0 Pin Description** 

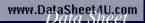
| Table 2: Pin List and Desc | cription  |   |
|----------------------------|-----------|---|
| Name                       | Pin       | Description   |
| DO                         | 31        | SPI data output   |
| www.bataSheet4U.com        | 32        | Logic Supply Input (needs external decoupling capacitor)  |
| GND                        | 1         | Ground, heat sink   |
| DI                         | 2         | SPI data in   |
| CLK                        | 3         | SPI clock input   |
| NXT                        | 4         | Next micro-step input                                     |
| DIR                        | 5         | Direction input   |
| ERRB                       | 6         | Error Output  |
| SLA                        | 7         | Speed Load Angle Output                                   |
| CPN                        | 9         | Negative connection of charge pump capacitor              |
| CPP                        | 10        | Positive connection of charge pump capacitor              |
| VCP                        | 11        | Charge-pump filter-capacitor                              |
| CLR                        | 12        | "Clear" = Chip Reset input                                |
| CSB                        | 13        | SPI chip select input                                     |
| VBB                        | 14        | High Voltage Supply Input                                 |
| MOTYP                      | 15, 16    | Negative end of phase Y coil output                       |
| GND                        | 17, 18    | Ground, heat sink   |
| MOTYN                      | 19, 20    | Positive end of phase Y coil output                       |
| MOTXN                      | 21, 22    | Positive end of phase X coil output                       |
| GND                        | 23, 24    | Ground, heat sink   |
| MOTXP                      | 25, 26    | Negative end of phase X coil output                       |
| VBB                        | 27        | High Voltage Supply Input                                 |
| 1                          | 8, 28, 30 | No Function (to be left open in normal operation)         |
| TST0                       | 29        | Test pin (to be tied to ground in normal operation) input |



#### 5.1 Package Thermal Characteristics

The NQFP is designed to provide superior thermal performance, and using an exposed die pad on the bottom surface of the package partly contributes to this. In order to take full advantage of this thermal performance, the PCB must have features to conduct heat away from the package. A thermal grounded pad with thermal vias can achieve this. With a layout as shown in <a href="Figure 3">Figure 3</a>: PCB Ground Plane Layout Condition, the thermal resistance junction – to – ambient can be brought down to a level of 30°C/W.





### 6.0 Electrical Specification

#### **6.1 Absolute Maximum Ratings**

Stresses above those listed in table below may cause immediate and permanent device failure. It is not implied that more that one of these conditions can be applied simultaneously.

Table 3: Absolute Maximum Ratings

| Symbol           | Parameter                                       |      | Max. | Units |
|------------------|---|------|------|-------|
| $V_{BB}$         | Analog DC supply voltage (1)                    | -0.3 | +40  | V     |
| $V_{DD}$         | Logic supply voltage                            | -0.3 | +7.0 | V     |
| Tstrg            | Storage temperature                             | -55  | +160 | °C    |
| Tamb             | Ambient temperature under bias                  | -50  | +150 | °C    |
| V <sub>ESD</sub> | Electrostatic discharges on component level (2) | -2   | +2   | kV    |

Notes:

- (1) For limited time <0.5s.
- (2) Human body model (100pF via 1.5 kΩ, according to JEDEC EIA-JESD22-A114-B).

#### **6.2 Recommend Operation Conditions**

Operating ranges define the limits for functional operation and parametric characteristics of the device. Note that the functionality of the chip outside these operating ranges is not guaranteed. Operating outside the recommended operating ranges for extended periods of time may affect device reliability.

Table 4: Operating Ranges

| Symbol         | Parameter                    | Min. | Max. | Unites |
|----------------|------------------------------|------|------|--------|
| $V_{BB}$       | Analog DC supply             | +6   | +30  | V      |
| $V_{DD}$       | Logic supply voltage         | 4.75 | 5.25 | V      |
| lddd           | Dynamic current (1)          |      | 18   | mA     |
| Ta             | Ambient temperature VBAT≤+18 | -40  | +125 | °C     |
| Ta             | Ambient temperature VBAT≤+29 | -40  | +85  | °C     |
| T <sub>i</sub> | Junction temperature         |      | +160 | °C     |

Notes:

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<sup>(1)</sup> Dynamic current is with oscillator running, all analogue cells active. All outputs unloaded, no floating inputs.

#### **6.3 DC Parameters**

The DC parameters are given for  $V_{BB}$  and temperature in their operating ranges unless otherwise specified. Convention: currents flowing in the circuit are defined as positive.

Table 5: DC Parameters

|                         | Parameters        |  | Damard Gard & Print                            |                       |                           |                       |      |
|-------------------------|-------------------|--|--|-----------------------|---------------------------|-----------------------|------|
| Symbol                  | Pin(s)            | Parameter  | Remark/Test Conditions                         | Min.                  | Тур.                      | Max.                  | Unit |
| Supply Ir               | puts              |  | 1  |                       |                           |                       |      |
| $V_{BB}$                | VBB               | Nominal operating supply range                                 |  | 6                     |                           | 30                    | V    |
| I <sub>bat</sub>        |                   | Total current consumption                                      | Unloaded outputs                               |                       |                           | 8                     | mA   |
| $V_{dd}$                | VDD               | Logic supply voltage   |  | 4.75                  | 5                         | 5.25                  | V    |
|                         | n-Reset (POR      |  |  |                       |                           |                       |      |
| $V_{DDH}$               | VDD               | Internal POR comparator threshold                              | VDD rising                                     | 4.0                   | 4.25                      | 4.4                   | V    |
| $V_{DDL}$               | VDD               | Internal POR comparator threshold                              | VDD falling                                    |                       | 3.68                      |                       | V    |
| Motordriv               | ver               |  |  |                       |                           |                       |      |
| l                       |                   | Max current through motor coil in                              |  |                       | 1600                      |                       | mA   |
| I <sub>MDmax,Peak</sub> |                   | normal operation   |  |                       | 1000                      |                       | IIIA |
| I <sub>MDmax.RMS</sub>  |                   | Max RMS current through coil in normal                         |  |                       | 800                       |                       | mA   |
| -IMDITIAX,RIMS          |                   | operation  |  |                       | 000                       |                       |      |
| I <sub>MDabs</sub>      |                   | Absolute error on coil current                                 |  | -10                   |                           | 10                    | %    |
| I <sub>MDrel</sub>      |                   | Error on current ratio I <sub>coilx</sub> / I <sub>coily</sub> |  | -7                    |                           | 7                     | %    |
| R <sub>HS</sub>         |                   | On-resistance high-side driver,                                | V <sub>bb</sub> = 12V, T <sub>j</sub> = 27 °C  |                       | 0.45                      | 0.56                  | Ω    |
| 1 113                   | MOTXP             | CUR[4:0] = 031   | $V_{bb} = 12V, T_j = 160  ^{\circ}C$           |                       | 0.94                      | 1.25                  | Ω    |
| R <sub>LS3</sub>        | MOTXN<br>MOTYP    | On-resistance low-side driver,                                 | $V_{bb} = 12V, T_j = 27  ^{\circ}C$            |                       | 0.45                      | 0.56                  | Ω    |
| 1 1253                  | MOTYN             | CUR[4:0] = 2331  | V <sub>bb</sub> = 12V, T <sub>j</sub> = 160 °C |                       | 0.94                      | 1.25                  | Ω    |
| R <sub>LS2</sub>        | WOTTN             | On-resistance low-side driver,                                 | $V_{bb} = 12V, T_j = 27  ^{\circ}C$            |                       | 0.90                      | 1.2                   | Ω    |
| INLS2                   |                   | CUR[4:0] = 1622  | $V_{bb} = 12V, T_j = 160  ^{\circ}C$           |                       | 1.9                       | 2.5                   | Ω    |
| R <sub>LS1</sub>        |                   | On-resistance low-side driver,                                 | $V_{bb} = 12V, T_j = 27  ^{\circ}C$            |                       | 1.8                       | 2.3                   | Ω    |
| INLS1                   |                   | CUR[4:0] = 915   | V <sub>bb</sub> = 12V, T <sub>j</sub> = 160 °C |                       | 3.8                       | 5.0                   | Ω    |
| R <sub>LS0</sub>        |                   | On-resistance low-side driver,                                 | V <sub>bb</sub> = 12V, T <sub>j</sub> = 27 °C  |                       | 3.6                       | 4.5                   | Ω    |
| INLS0                   |                   | CUR[4:0] = 08  | V <sub>bb</sub> = 12V, T <sub>j</sub> = 160 °C |                       | 7.5                       | 10                    | Ω    |
| I <sub>Mpd</sub>        |                   | Pull-down current  | HiZ mode                                       |                       | 0.5                       |                       | mA   |
| Logic Inp               | uts               |  |  |                       |                           |                       |      |
| I <sub>leak</sub>       | DI, CLK           | Input leakage (3)  | Tj = 160 °C                                    |                       |                           | 1                     | μA   |
| V <sub>inL</sub>        |                   | Logic low threshold  |  |                       |                           | 1.5                   | ·V   |
| V <sub>inH</sub>        | CLR, CSB          | Logic high threshold   |  | 3.5                   |                           |                       | V    |
| www.DataSh              | eet4lCLRn<br>TST0 | Internal pull-down resistor                                    |  | 120                   |                           | 300                   | kΩ   |
|                         | Warning and       | Shutdown   |  |                       |                           |                       |      |
|                         | Warring and       | Thermal warning  |  | 138                   | 145                       | 152                   | °C   |
| T <sub>tw</sub> (1) (2) |                   | Thermal shutdown   |  | 130                   | T <sub>tw</sub> + 20      | 132                   | °C   |
| Charge P                | Lump              | Thermal Shuldown   |  |                       | 1 <sub>tw</sub> + 20      |                       | C    |
| Charge P                | ump               |  | 6\/-\/ - 15\/                                  |                       | 2*1/ 25                   |                       | V    |
| $V_{cp}$                | VCP               | Output voltage   | 6V< V <sub>BB</sub> < 15V                      | V 112.5               | 2 * V <sub>BB</sub> – 2.5 | \/ \145.5             |      |
|                         | VCP               | Futament buffer consists                                       | 15V < V <sub>BB</sub> < 30V                    | V <sub>BB</sub> +12.5 | V <sub>BB</sub> +14       | V <sub>BB</sub> +15.5 | V    |
| C <sub>buffer</sub>     | ODD OD!           | External buffer capacitor                                      |  | 180                   | 220                       | 470                   | nF   |
| $C_{pump}$              | CPP CPN           | External pump capacitor  |  | 180                   | 220                       | 470                   | nF   |

#### Notes:

- (1) No more than 100 cumulated hours in life time above  $\mathsf{Tt}_{\mathsf{w}}$ .
- (2) Thermal shutdown and low temperature warning are derived from thermal warning.
- (3) Not valid for pins with internal pull-down resistor.



#### **6.4 AC Parameters**

The AC parameters are given for  $V_{BB}$  and temperature in their operating ranges.

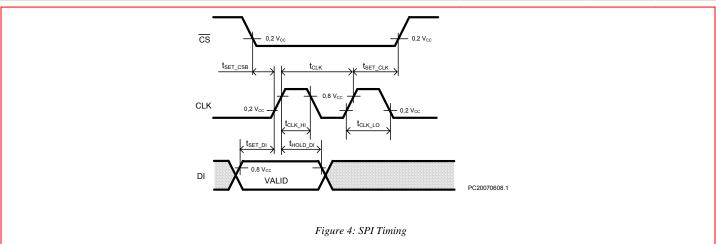
Table 6: AC Parameters

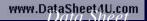
| Symbol            | Pin(s)      | Parameter  | Remark/Test Conditions                               | Min. | Тур. | Max. | Unit               |
|-------------------|-------------|--|--|------|------|------|--------------------|
| Internal          | Oscillator  |  |  |      |      |      |                    |
| osc               |             | Frequency of internal oscillator                           |  | 3.6  | 4    | 4.4  | MHz                |
| Motordri          | ver         | •  | ·  |      |      |      |                    |
|                   |             | PWM frequency  | Frequency depends only on                            | 20.8 | 22.8 | 24.8 | kHz                |
| PWM               | MOTxx       | Double PWM frequency                                       | internal oscillator                                  | 41.6 | 45.6 | 49.6 | kHz                |
|                   | WOTXX       | PWM Jitter frequency                                       |  |      | tbd  |      | Hz                 |
| i                 |             | PWM Jitter depth   |  |      | tbd  |      | % f <sub>PWM</sub> |
|                   |             |  | EMC[1:0] = 00  |      | 150  |      | V/µs               |
| -h                | orise MOTxx | turn-on voltage slope, 10% to 90%                          | EMC[1:0] = 01  |      | 100  |      | V/µs               |
| b <sub>rise</sub> | WOTXX       | turn-on voitage slope, 10% to 90%                          | EMC[1:0] = 10  |      | 50   |      | V/µs               |
|                   |             |  | EMC[1:0] = 11  |      | 25   |      | V/µs               |
|                   |             |  | EMC[1:0] = 00  |      | 150  |      | V/µs               |
| -h                | MOTxx       | turn-off voltage slope, 90% to 10%                         | EMC[1:0] = 01  |      | 100  |      | V/µs               |
| b <sub>fall</sub> | WOTXX       |  | EMC[1:0] = 10  |      | 50   |      | V/µs               |
|                   |             |  | EMC[1:0] = 11  |      | 25   |      | V/µs               |
| Digital O         | utputs      |  |  |      |      |      |                    |
| H2L               | DO<br>ERRB  | Output fall-time from $V_{\text{inH}}$ to $V_{\text{inL}}$ | Capacitive load 400pF and pull-up resistor of 1.5 kΩ |      |      | 50   | ns                 |
| Charge F          | Pump        |  |  |      |      |      |                    |
| CP                | CPN CPP     | Charge pump frequency                                      |  |      | 250  |      | kHz                |
| CPU               | MOTxx       | Start-up time of charge pump                               | Spec external components                             |      |      |      |                    |
| CLR Fun           | ction       |  |  |      |      |      |                    |
| CLR               | CLR         | Hard reset duration time                                   |  | 20   |      | 90   | μs                 |

### 6.5 SPI Timing

Table 7: SPI Timing Parameters

| Symbol                | Parameter   | Min. | Тур. | Max. | Unit |
|-----------------------|---|------|------|------|------|
| t <sub>CLK</sub>      | SPI clock period                                    | 1    |      |      | μS   |
| t <sub>CLK_HIGH</sub> | SPI clock high time                                 | 100  |      |      | ns   |
| t <sub>CLK_LOW</sub>  | SPI clock low time                                  | 100  |      |      | ns   |
| www.DataSheet4        | DPset up time, valid data before rising edge of CLK | 50   |      |      | ns   |
| t <sub>HOLD_DI</sub>  | DI hold time, hold data after rising edge of CLK    | 50   |      |      | ns   |
| t <sub>CSB_HIGH</sub> | CSB high time                                       | 2.5  |      |      | μS   |
| t <sub>SET_CSB</sub>  | CSB set up time, CSB low before rising edge of CLK  | 100  |      |      | ns   |
| t <sub>SET_CLK</sub>  | CLK set up time, CLK low before rising edge of CSB  | 100  |      |      | ns   |





## 7.0 Typical Application Schematic

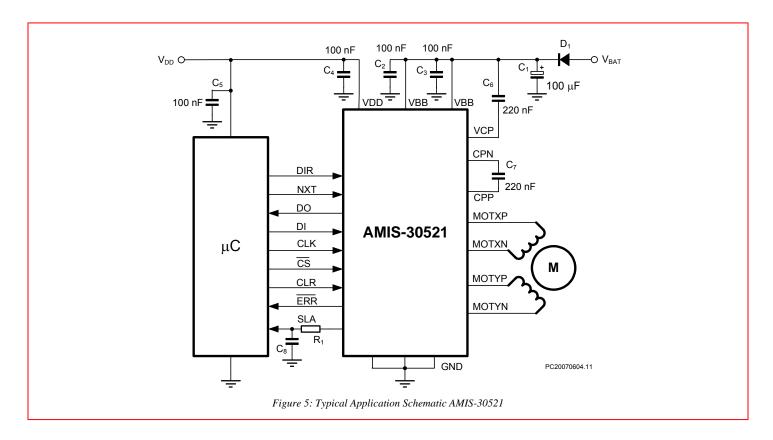


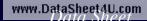
Table 8: External Components List and Description

| Component          | Function  | Typ. Value  | Tolerance | Unit |
|--------------------|---|-------------|-----------|------|
| C <sub>1</sub>     | V <sub>BB</sub> buffer capacitor <sup>(1)</sup> | 100         | -20 +80%  | μF   |
| www.DataSheet4U.co | M V <sub>BB</sub> decoupling block capacitor    | 100         | -20 +80%  | nF   |
| C <sub>4</sub>     | V <sub>DD</sub> buffer capacitor                | 220         | +/- 20 %  | nF   |
| C <sub>5</sub>     | V <sub>DD</sub> buffer capacitor                | 100         | +/- 20%   | nF   |
| C <sub>6</sub>     | Charge pump buffer capacitor                    | 220         | +/- 20%   | nF   |
| C <sub>7</sub>     | Charge pump pumping capacitor                   | 220         | +/- 20%   | nF   |
| C <sub>8</sub>     | Low pass filter SLA                             | 1           | +/- 20%   | nF   |
| R <sub>1</sub>     | Low pass filter SLA                             | 5.6         | +/- 1%    | kΩ   |
| D <sub>1</sub>     | Optional reverse protection diode               | e.g. 1N4003 |           |      |

Notes:

(1) Low ESR < 10hm.





### 8.0 Functional Description

#### 8.1 H-Bridge Drivers

A full H-bridge is integrated for each of the two stator windings. Each H-bridge consists of two low-side and two high-side N-type MOSFET switches. Writing logic '0' in bit <MOTEN> disables all drivers (high-impedance). Writing logic '1' in this bit enables both bridges and current can flow in the motor stator windings.

In order to avoid large currents through the H-bridge switches, it is guaranteed that the top- and bottom-switches of the same half-bridge are never conductive simultaneously (interlock delay).

A two-stage protection against shorts on motor lines is implemented. In a first stage, the current in the driver is limited. Secondly, when excessive voltage is sensed across the transistor, the transistor is switched-off.

In order to reduce the radiated/conducted emission, voltage slope control is implemented in the output switches. The output slope is defined by the gate-drain capacitance of output transistor and the (limited) current that drives the gate. There are two trimming bits for slope control (Table 25: SPI Control Parameter Overview EMC[1:0]).

The power transistors are equipped with so-called "active diodes": when a current is forced trough the transistor switch in the reverse direction, i.e. from source to drain, then the transistor is switched on. This ensures that most of the current flows through the channel of the transistor instead of through the inherent parasitic drain-bulk diode of the transistor.

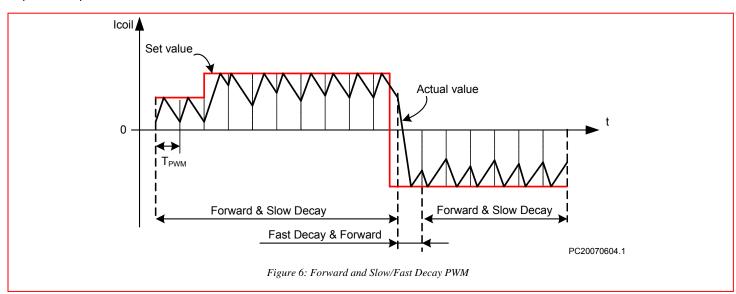
Depending on the desired current range and the micro-step position at hand, the Rdson of the low-side transistors will be adapted such that excellent current-sense accuracy is maintained. The Rdson of the high-side transistors remain unchanged, see <u>Table 5: DC Parameters</u> for more details.

#### **8.2 PWM Current Control**

A PWM comparator compares continuously the actual winding current with the requested current and feeds back the information to a digital regulation loop. This loop then generates a PWM signal, which turns on/off the H-bridge switches. The switching points of the PWM duty-cycle are synchronized to the on-chip PWM clock. The frequency of the PWM controller can be doubled and an artificial jitter can be added (<u>Table 14: SPI Control Register 1</u>). The PWM frequency will not vary with changes in the supply voltage. Also variations in motor-speed or load-conditions of the motor have no effect. There are no external components required to adjust the PWM frequency.

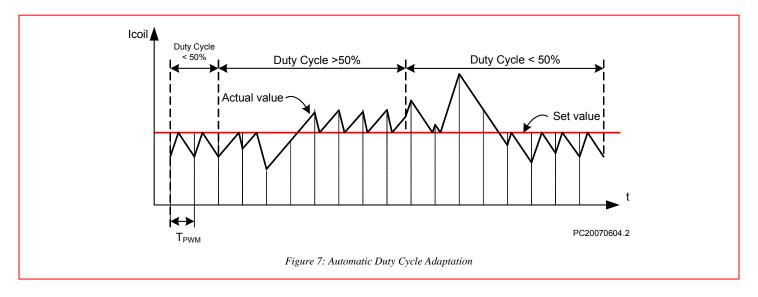
#### 8.2.1. Automatic Forward and Slow-Fast Decay

The PWM generation is in steady-state using a combination of forward and slow-decay. The absence of fast-decay in this mode, "guarantees the lowest possible current-ripple "by design". For transients to lower current levels, fast-decay is automatically activated to allow high-speed response. The selection of fast or slow decay is completely transparent for the user and no additional parameters are required for operation.



#### 8.2.2. Automatic Duty Cycle Adaptation

Incase the supply voltage is lower than 2\*Bemf, then the duty cycle of the PWM is adapted automatically to >50% to maintain the requested average current in the coils. This process is completely automatic and requires no additional parameters for operation. The over-all current-ripple is divided by two if PWM frequency is doubled (Table 14: SPI Control Register 1).



#### 8.3 Step Translator

#### 8.3.1. Step Mode

The step translator provides the control of the motor by means of SPI register Stepmode: SM[2:0], SPI register DIRCNTRL, and input pins DIR and NXT. It is translating consecutive steps in corresponding currents in both motor coils for a given step mode.

One out of seven possible stepping modes can be selected through SPI-bits SM[2:0] (<u>Table 26: SPI Control Parameter Overview SM[2:0]</u>) After power-on or hard reset, the coil-current translator is set to the default 1/32 micro-stepping at position '0'. Upon changing the step mode, the translator jumps to position 0\* of the corresponding stepping mode. When remaining in the same step mode, we subsequent translator positions are all in the same column and increased or decreased with 1. <u>Table 10:</u> Circular Translator Table lists the output current versus the translator position.

As shown in Figure 8 the output current-pairs can be projected approximately on a circle in the  $(I_x,I_y)$  plane. There is, however, one exception: uncompensated half step. In this step mode the currents are not regulated to a fraction of Imax but are in all intermediate steps regulated at 100 percent. In the  $(I_x,I_y)$  plane the current-pairs are projected on a square. Table 9: Square Translator Table for Umcompensated Half StepSM[2:0] = 101 lists the output current versus the translator position for this case.

Table 9: Square Translator Table for Umcompensated Half StepSM[2:0] = 101

| Stepmode ( SM[2:0] )    | % of I | max    |
|-------------------------|--------|--------|
| 101                     | Coil x | Coil y |
| Uncompensated Half-Step | Conx   | Con y  |
| 0*                      | 0      | 100    |
| 1                       | 100    | 100    |
| 2                       | 100    | 0      |
| 3                       | 100    | -100   |
| 4                       | 0      | -100   |
| 5                       | -100   | -100   |
| 6                       | -100   | 0      |
| 7                       | -100   | 100    |



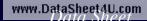
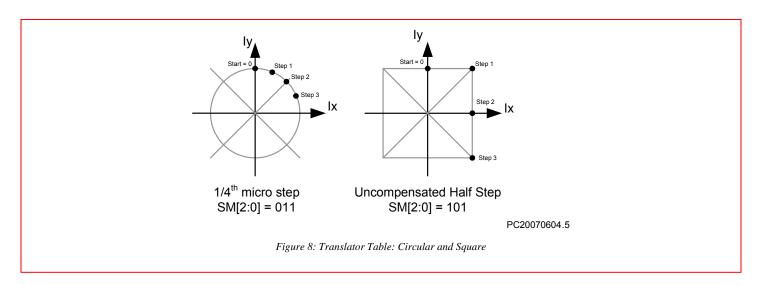


Table 10: Circular Translator Table

| . 45.6 10. | Circular Sto      |       | ( SM[2:0 | 1)  |     | % of         | lmax           |            | Ste          | epmode ( | ( SM[2:0] | )   |     | % of           | lmax           |
|------------|-------------------|-------|----------|-----|-----|--------------|----------------|------------|--------------|----------|-----------|-----|-----|----------------|----------------|
| 000        | 001               | 010   | 011      | 100 | 110 |              |                | 000        | 001          | 010      | 011       | 100 | 110 |                |                |
| 1/32       | 1/16              | 1/8   | 1/4      | 1/2 | FS  | Coil x       | Coil y         | 1/32       | 1/16         | 1/8      | 1/4       | 1/2 | FS  | Coil x         | Coil y         |
| '0'        | 0*                | 0*    | 0*       | 0*  | -   | 0            | 100            | 64         | 32           | 16       | 8         | 4   | гэ  | 0              | -100           |
| 1          | -                 | -     | -        | -   | -   | 3.5          | 98.8           | 65         | -            | -        | -         | -   | -   | -3.5           | -98.8          |
| 2          | 1                 | -     | -        | -   | -   | 8.1          | 97.7           | 66         | 33           | -        | -         | -   | -   | -8.1           | -97.7          |
| 3          | -                 | -     | -        | -   | -   | 12.7         | 96.5           | 67         | -            | -        | -         | -   | -   | -12.7          | -96.5          |
| 5          | 2                 | 1 -   | -        |     | -   | 17.4<br>22.1 | 95.3<br>94.1   | 68<br>69   | 34           | 17       | -         | -   | -   | -17.4<br>-22.1 | -95.3<br>-94.1 |
| 6          | 3                 | -     | -        | -   | -   | 26.7         | 93             | 70         | 35           | _        | -         | _   | -   | -26.7          | -93            |
| 7          | -                 | -     | -        | -   | -   | 31.4         | 91.8           | 71         | -            | -        | -         | -   | -   | -31.4          | -91.8          |
| 8          | 4                 | 2     | 1        | -   | -   | 34.9         | 89.5           | 72         | 36           | 18       | 9         | -   | -   | -34.9          | -89.5          |
| 9          | 5                 | -     | -        | -   | -   | 38.3         | 87.2           | 73         | 37           | -        | -         | -   | -   | -38.3          | -87.2          |
| 11         | -                 | -     | -        | -   | -   | 43<br>46.5   | 84.9<br>82.6   | 74<br>75   | - 3 <i>1</i> | -        | -         | -   | -   | -43<br>-46.5   | -84.9<br>-82.6 |
| 12         | 6                 | 3     | -        | -   | -   | 50           | 79             | 76         | 38           | 19       | -         | -   | -   | -50            | -79            |
| 13         | -                 | _     | -        | -   | -   | 54.6         | 75.5           | 77         | -            | -        | -         | -   | -   | -54.6          | -75.5          |
| 14         | 7                 | -     | -        | -   | -   | 58.1         | 72.1           | 78         | 39           | -        | -         | -   | -   | -58.1          | -72.1          |
| 15<br>16   | - 8               | 4     | 2        | 1   | 1   | 61.6<br>65.1 | 68.6<br>65.1   | 79<br>80   | 40           | 20       | 10        | 5   | 3   | -61.6<br>-65.1 | -68.6<br>-65.1 |
| 17         | -                 | -     | -        | -   | -   | 68.6         | 61.6           | 81         | -            | -        | -         | -   | -   | -68.6          | -61.6          |
| 18         | 9                 | -     | -        | -   | -   | 72.1         | 58.1           | 82         | 41           | -        | -         | -   | -   | -72.1          | -58.1          |
| 19         | -                 |       | -        | -   | -   | 75.5         | 54.6           | 83         | -            | -        | -         | -   | -   | -75.5          | -54.6          |
| 20<br>21   | 10                | 5     | -        | -   | -   | 79<br>82.6   | 50             | 84<br>85   | 42           | 21       | -         | -   | -   | -79            | -50            |
| 22         | 11                | -     | -        | -   | -   | 84.9         | 46.5<br>43     | 86         | 43           | -        | _         | -   | -   | -82.6<br>-84.9 | -46.5<br>-43   |
| 23         | -                 | -     | -        | -   | -   | 87.2         | 38.3           | 87         | -            | -        | -         | _   | -   | -87.2          | -38.3          |
| 24         | 12                | 6     | 3        | -   | -   | 89.5         | 34.9           | 88         | 44           | 22       | 11        | -   | -   | -89.5          | -34.9          |
| 25         | -                 | -     | -        | -   | -   | 91.8         | 31.4           | 89         | -            | -        | -         | -   | -   | -91.8          | -31.4          |
| 26<br>27   | 13                | -     | -        | -   | -   | 93<br>94.1   | 26.7<br>22.1   | 90<br>91   | 45           | -        | -         | -   | -   | -93<br>-94.1   | -26.7<br>-22.1 |
| 28         | 14                | 7     | _        |     | _   | 95.3         | 17.4           | 92         | 46           | 23       | _         | _   | _   | -95.3          | -17.4          |
| 29         | -                 | -     | -        | -   | -   | 96.5         | 12.7           | 93         | -            |          | -         | -   | -   | -96.5          | -12.7          |
| 30         | 15                | -     | -        | -   | -   | 97.7         | 8.1            | 94         | 47           | -        | -         | -   | -   | -97.7          | -8.1           |
| 31<br>32   | -<br>16           | 8     | 4        | 2   | -   | 98.8<br>100  | 3.5<br>0       | 95<br>96   | 48           | 24       | 12        | - 6 | -   | -98.8<br>-100  | -3.5<br>0      |
| 33         | -                 | -     | -        | -   | -   | 98.8         | -3.5           | 97         | -            | -        | -         | -   | -   | -98.8          | 3.5            |
| 34         | 17                | -     | -        | -   | -   | 97.7         | -8.1           | 98         | 49           | _        | -         | -   | -   | -97.7          | 8.1            |
| 35         | -                 | -     | -        | -   | -   | 96.5         | -12.7          | 99         | -            | -        | -         | -   | -   | -96.5          | 12.7           |
| 36         | 18                | 9     | -        | -   | -   | 95.3         | -17.4          | 100        | 50           | 25       | -         | -   | -   | -95.3          | 17.4           |
| 37<br>38   | -<br>19           | -     | -        | -   | -   | 94.1<br>93   | -22.1<br>-26.7 | 101<br>102 | -<br>51      | -        | -         | -   | -   | -94.1<br>-93   | 22.1<br>26.7   |
| 39         | -                 | -     | -        | -   | -   | 91.8         | -31.4          | 103        | -            | -        | -         | -   | -   | -91.8          | 31.4           |
|            | hee <b>20</b> U.c | om 10 | 5        | -   | -   | 89.5         | -34.9          | 104        | 52           | 26       | 13        | -   | -   | -89.5          | 34.9           |
| 41         | - 04              | -     | -        | -   | -   | 87.2         | -38.3          | 105        | -            | -        | -         | -   | -   | -87.2          | 38.3           |
| 42         | 21                | -     | -        | -   | -   | 84.9<br>82.6 | -43<br>-46.5   | 106<br>107 | 53           | -        | -         | -   | -   | -84.9<br>-82.6 | 43<br>46.5     |
| 44         | 22                | 11    | -        | _   | -   | 79           | -50            | 107        | 54           | 27       | -         | _   | -   | -79            | 50             |
| 45         | -                 | -     | -        | -   | -   | 75.5         | -54.6          | 109        | -            | -        | -         | -   | -   | -75.5          | 54.6           |
| 46         | 23                | -     | -        | -   | -   | 72.1         | -58.1          | 110        | 55           | -        | -         | -   | -   | -72.1          | 58.1           |
| 47<br>48   | 24                | 12    | 6        | 3   | 2   | 68.6         | -61.6<br>-65.1 | 111<br>112 | -<br>56      | 28       | 14        | 7   | 0*  | -68.6<br>-65.1 | 61.6           |
| 49         | - 24              | -     | -        | -   | -   | 65.1<br>61.6 | -65.1<br>-68.6 | 113        | -            | -        | -         | -   | -   | -63.1<br>-61.6 | 65.1<br>68.6   |
| 50         | 25                | -     | -        | _   | -   | 58.1         | -72.1          | 114        | 57           | -        | -         | -   | -   | -58.1          | 72.1           |
| 51         | _                 | -     | -        | -   | -   | 54.6         | -75.5          | 115        | -            | -        | -         | -   | -   | -54.6          | 75.5           |
| 52         | 26                | 13    | -        | -   | -   | 50           | -79            | 116        | 58           | 29       | -         | -   | -   | -50            | 79             |
| 53<br>54   | 27                | -     | -        | -   | -   | 46.5<br>43   | -82.6<br>-84.9 | 117<br>118 | -<br>59      | -        | -         | -   | -   | -46.5<br>-43   | 82.6<br>84.9   |
| 55         | -                 | -     | -        | -   | -   | 38.3         | -87.2          | 119        | -            | -        | -         | -   | -   | -38.3          | 87.2           |
| 56         | 28                | 14    | 7        | -   | -   | 34.9         | -89.5          | 120        | 60           | 30       | 15        | -   | -   | -34.9          | 89.5           |
| 57         | -                 | -     | _        | -   | -   | 31.4         | -91.8          | 121        | -            | -        | -         | -   | -   | -31.4          | 91.8           |
| 58         | 29                | -     | -        | -   | -   | 26.7         | -93            | 122        | 61           | -        | -         | -   | -   | -26.7          | 93             |
| 59<br>60   | 30                | 15    | -        | -   | -   | 22.1<br>17.4 | -94.1<br>-95.3 | 123<br>124 | 62           | 31       | -         | -   | -   | -22.1<br>-17.4 | 94.1<br>95.3   |
| 61         | -                 | -     | -        | -   | -   | 12.7         | -96.5          | 125        | -            | -        | -         | -   | -   | -12.7          | 96.5           |
| 62         | 31                | -     | -        | -   | -   | 8.1          | -97.7          | 126        | 63           | -        | -         | -   | -   | -8.1           | 97.7           |
| 63         | -                 | -     | -        | -   | -   | 3.5          | -98.8          | 127        | -            | -        | -         | -   | -   | -3.5           | 98.8           |



#### 8.3.2. Direction

The direction of rotation is selected by means of following combination of the DIR input pin and the SPI-controlled direction bit <DIRCTRL>. (Table 14: SPI Control Register 1)

#### 8.3.3. NXT Input

Changes on the NXT input will move the motor current one step up/down in the translator table. Depending on the NXT-polarity bit <NXTP> (Table 14: SPI Control Register 1), the next step is initiated either on the rising edge or the falling edge of the NXT input.

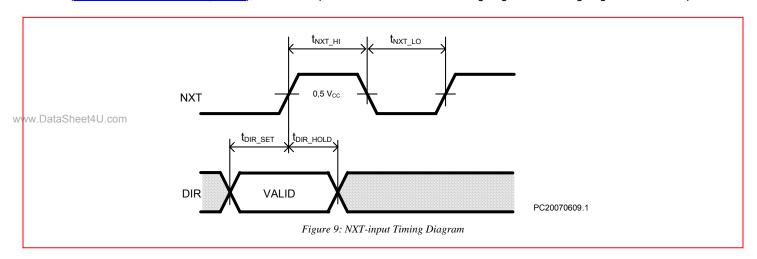


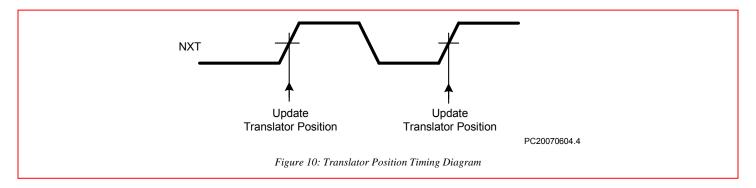
Table 11: Timing Table NXT Pin

| Symbol                | Parameter                              | Min. | Тур. | Max. | Unit |
|-----------------------|--|------|------|------|------|
| t <sub>NXT_HI</sub>   | NXT minimum, high pulse width          | 2    |      |      | μs   |
| t <sub>NXT_LO</sub>   | NXT minimum, low pulse width           | 2    |      |      | μs   |
| t <sub>DIR_SET</sub>  | NXT hold time, following change of DIR | 500  |      |      | μs   |
| t <sub>DIR_HOLD</sub> | NXT hold time, before change of DIR    | 500  |      |      | μs   |



#### 8.3.4. Translator Position

The translator position can be read in <u>Table 30</u>: <u>SPI Status Register 3</u>. This is a 7-bit number equivalent to the 1/32<sup>th</sup> micro-step from <u>Table 10</u>: <u>Circular Translator Table</u>. The translator position is updated immediately following a NXT trigger.

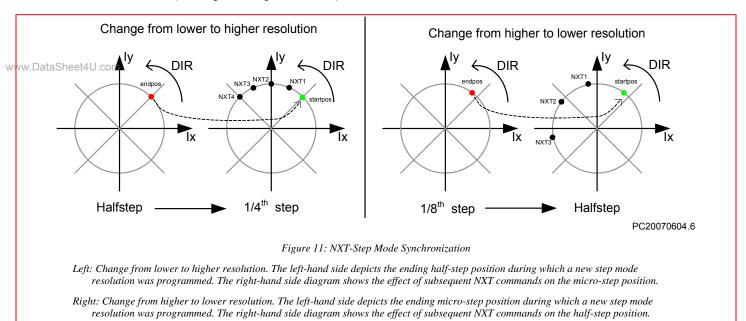


#### 8.3.5. Synchronization of Step Mode and NXT Input

When step mode is re-programmed to another resolution (<u>Table 13: SPI Control Register 0</u>), then this is put in effect immediately upon the first arriving "NXT" input. If the micro-stepping resolution is increased (see <u>Figure 11</u>) then the coil currents will be regulated to the nearest micro-step, according to the fixed grid of the increased resolution. If however the micro-stepping resolution is decreased, then it is possible to introduce an offset (or phase shift) in the micro-step translator table.

If the step resolution is decreased at a translator table position that is shared both by the old and new resolution setting, then the offset is zero and micro-stepping is proceeds according to the translator table.

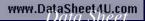
If the translator position is <u>not</u> shared both by the old and new resolution setting, then the micro-stepping proceeds with an offset relative to the translator table (See Figure 10 right hand side).



#### Note:

It is advised to reduce the micro-stepping resolution only at micro-step positions that overlap with desired micro-step positions of the new resolution.



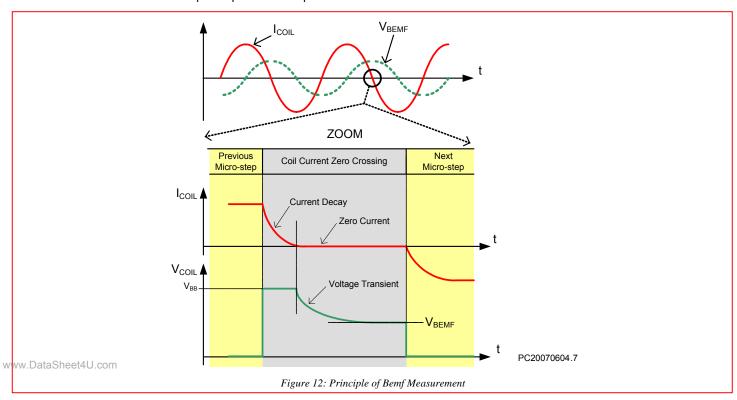


#### 8.4 Programmable Peak-Current

The amplitude of the current waveform in the motor coils (coil peak current = Imax) is adjusted by means of an SPI parameter "CUR[4:0]" (<u>Table 13: SPI Control Register 0</u>). Whenever this parameter is changed, the coil-currents will be updated immediately at the next PWM period. More information can be found in <u>Table 24: SPI Control Parameter Overview CUR[4:0]</u>.

#### 8.5 Speed and Load Angle Output

The SLA-pin provides an output voltage that indicates the level of the Back-e.m.f. voltage of the motor. This Back-e.m.f. voltage is sampled during every so-called "coil current zero crossings". Per coil, two zero-current positions exist per electrical period, yielding in total four zero-current observation points per electrical period.



Because of the relatively high recirculation currents in the coil during current decay, the coil voltage  $V_{COIL}$  shows a transient behavior. As this transient is not always desired in application software, two operating modes can be selected by means of the bit <SLAT> (see "SLA-transparency" in <u>Table 15: SPI Control Register 2</u>). The SLA pin shows in "transparent mode" full visibility of the voltage transient behavior. This allows a sanity-check of the speed-setting versus motor operation and characteristics and supply voltage levels. If the bit "SLAT" is cleared, then only the voltage samples at the end of each coil current zero crossing are visible on the SLA-pin. Because the transient behavior of the coil voltage is not visible anymore, this mode generates smoother Back e.m.f. input for post-processing, e.g. by software.

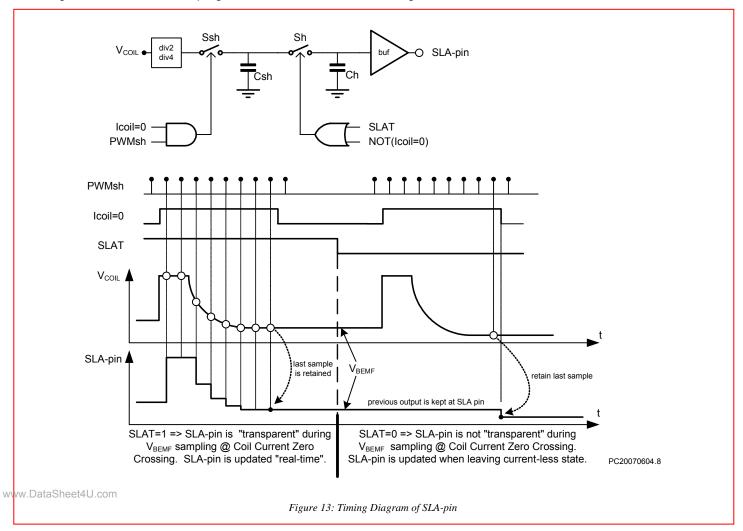
In order to bring the sampled Back e.m.f. to a descent output level (0 to 5V), the sampled coil voltage  $V_{COIL}$  is divided by 2 or by 4. This divider is set through an SPI bit <SLAG>. (Table 15: SPI Control Register 2)

Table 12: Parameter Table SLA Pin

| Symbol            | Pin(s)                            | Parameter   | Remark/Test Conditions   | Min. | Typ.     | Max. | Unit |
|-------------------|-----------------------------------|---|--------------------------|------|----------|------|------|
| V <sub>out</sub>  |                                   | Output voltage range                                    |                          | 0.5  | <u> </u> | 4.5  | V    |
| $V_{\text{off}}$  |                                   | Output offset the SLA pin                               | 0.2V < Vsla < Vdd - 0,2V | -20  |          | 20   | mV   |
| R <sub>out</sub>  | SLA                               | Output resistance SLA pin                               |                          |      |          | 1    | kΩ   |
| C <sub>load</sub> | OLA                               | Load capacitance SLA pin                                |                          |      |          | 50   | pF   |
| G .               | 1                                 | Gain of SLA pin = V <sub>BEME</sub> / V <sub>COII</sub> | SLAG=0                   |      | 0,5      |      |      |
| G <sub>sla</sub>  | Gaill Of SLA PITI - VBEMF / VCOIL | SLAG=1  |                          | 0,25 |          |      |      |



The following drawing illustrates the operation of the SLA-pin and the transparency-bit. "PWMsh" and "Icoil=0" are internal signals that define together with SLAT the sampling and hold moments of the coil voltage.



#### 8.6 Warning, Error Detection and Diagnostics Feedback

#### 8.6.1. Thermal Warning and Shutdown

When junction temperature rises above  $T_{TW}$ , the thermal warning bit  $<_{TW}>$  is set (<u>Table 27: SPI Status Register 0</u>). If junction temperature increases above thermal shutdown level, then the circuit goes in "thermal shutdown" mode ( $<_{TSD}>$ ) and all driver transistors are disabled (high impedance) (<u>Table 29: SPI Status Register 2</u>). The conditions to reset flag  $<_{TSD}>$  is to be at a temperature lower than  $T_{TW}$  and to clear the  $<_{TSD}>$  flag by reading it using any SPI read command.

#### 8.6.2. Over-Current Detection

The over-current detection circuit monitors the load current in each activated output stage. If the load current exceeds the over-current detection threshold, then the over-current flag is set and the drivers are switched off to reduce the power dissipation and to protect the integrated circuit. Each driver transistor has an individual detection bit in the <u>Table 28: SPI Status Register 1</u> and <u>Table 29: SPI </u>



## **AMIS-30521 Micro-stepping Motor Driver**



#### 8.6.3. Open Coil Detection

Open coil detection is based on the observation of 100 percent duty cycle of the PWM regulator. If in a coil 100 percent duty cycle is detected for longer than 200ms then the related driver transistors are disabled (high-impedance) and an appropriate bit in the SPI status register is set (<OPENX> or <OPENY>). (Table 27: SPI Status Register 0)

#### 8.6.4. Charge Pump Failure

The charge pump is an important circuit that guarantees low Rdson for all drivers, especially for low supply voltages. If supply voltage is too low or external components are not properly connected to guarantee Rdson of the drivers, then the bit <CPFAIL> is set in the Table 27: SPI Status Register 0. Also after power-on-reset the charge pump voltage will need some time to exceed the required threshold. During that time <CPFAIL> will be set to "1".

#### 8.6.5. Error Output

This is a digital output to flag a problem to the external microcontroller. The signal on this output is active low and the logic combination of:

NOT(ERRB) = <TW> OR <TSD> OR <OVCXij> OR < OVCYij> OR <OPENi> OR <CPFAIL>

#### 8.7 CLR pin (=Hard Reset)

Logic 0 on CLR pin allows normal operation of the chip. To reset the complete digital inside AMIS-30521, the input CLR needs to be pulled to logic 1 during minimum time given by T<sub>CLR</sub>. (<u>Table 6: AC Parameters</u>) This reset function clears all internal registers without the need of a power-cycle. The operation of all analog circuits is depending on the reset state of the digital, charge pump remains active. Logic 0 on CLR pin resumes normal operation again.

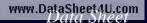
#### 8.8 Sleep Mode

The bit <SLP> in <u>Table 15: SPI Control Register 2</u> is provided to enter a so-called "sleep mode". This mode allows reduction of current-consumption when the motor is not in operation. The effect of sleep mode is as follows:

- The drivers are put in HiZ
- All analog circuits are disabled and in low-power mode
- All internal registers are maintaining their logic content
- www.DataSheeta.com DIR inputs are forbidden
  - SPI communication remains possible (slight current increase during SPI communication)
  - Reset of chip is possible through CLR pin
  - Oscillator and digital clocks are silent, except during SPI communication

Normal operation is resumed after writing logic '0' to bit <SLP>. A start-up time is needed for the charge pump to stabilize. After this time, NXT commands can be issued.





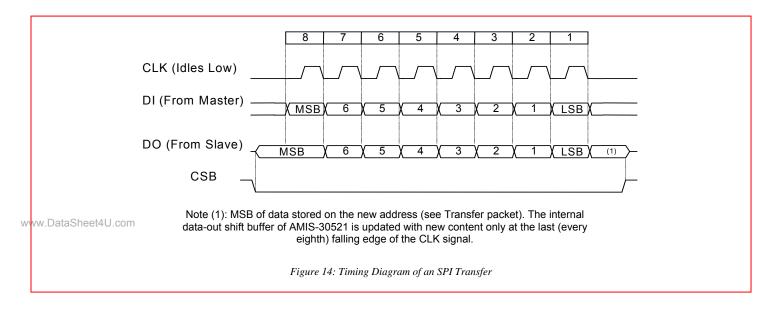
#### 9.0 SPI interface

The serial peripheral interface (SPI) is used to allow external microcontroller (MCU) to communicate with the device. The implemented SPI block is flexible enough to interface directly with numerous microcontrollers from several manufacturers. AMIS-30521 acts always as a slave and it can't initiate any transmission. The operation of the device is configured and controlled by means of SPI registers, which are observable for read and/or write from the master.

#### 9.1 SPI Transfer Format and Pin Signals

During an SPI transfer, data is simultaneously transmitted (shifted out serially) and received (shifted in serially). A serial clock line (CLK) synchronizes shifting and sampling of the information on the two serial data lines (DO and DI). DO signal is the output from the slave, and DI signal is the output from the master. A slave select line (CSB) allows individual selection of a slave SPI device in a multiple-slave system. The CSB line is active low. If AMIS-30521 is not selected, DO is in high impedance state and it does not interfere with SPI bus activities. Since AMIS-30521 always clocks data out on the falling edge and samples data in on rising edge of clock, the MCU SPI port must be configured to match this operation. SPI clock idles low between the transferred bytes.

The diagram below is both a master and a slave timing diagram since CLK, DO and DI pins are directly connected between the master and the slave.



#### 9.2 Transfer Packet

Serial data transfer is assumed to follow MSB first rule. The transfer packet contains one or more 8-bit characters (bytes).

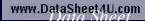
| MSB  |      |      |         |            |       |       | LSB   | MSB   | LSB     |
|------|------|------|---------|------------|-------|-------|-------|-------|---------|
|      |      |      | Command | and Addres | SS    |       |       | Data  | byte    |
|      |      |      |         |            |       |       |       |       |         |
| Cmd2 | Cmd1 | Cmd0 | Addr4   | Addr3      | Addr2 | Addr1 | Addr0 | Data7 | - Data0 |

The first byte contains command and SPI Register address and will be sent upfront of the packet to indicate to AMIS-30521 the chosen register and the type of operation.

There are two possible commands for the master in normal operation mode of AMIS-30521:

READ from SPI register: Cmd2 = 0
 WRITE to SPI register: Cmd2 = 1





WRITE command executed for read-only register will not affect the register and the device operation. In case of READ command the data byte is optional. If a byte is transmitted after READ command it is also interpreted as a command (see examples below).

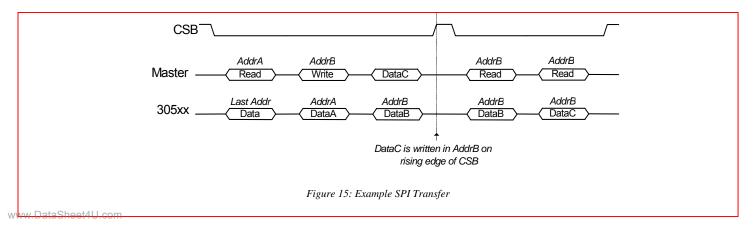
If the master reads data from a status register (<u>SPI Status Register Description</u>), then the most significant bit (Data 7) represents a parity of Data6 to Data0 bits. If the number of logical ones in the data is odd then the parity bit equals 1. If the number of logical ones is even then the parity bit equals 0. This is a simple mechanism to protect against noise and to verify the correct transmission operation and the consistency of the status data. If a parity check error occurs, the master could initiate an additional READ command to obtain the status again.

The CSB line is active low and may remain low between each successive READ commands. There is only one exception of this rule: if error condition is latched in status register (SPI Status Register Description) and the master needs to clear the status bits then exactly after READ command of a latched status register CSB line should go from low to high. This is explained in the following note:

**Note:** The status registers and ERRB pin (SPI Status Register Description) are updated by the internal system clock only when CSB line is high. It is recommended to keep the CSB line high always when the SPI bus is idle.

If the master sends WRITE command, then the incoming data will be stored in the corresponding register only if CSB goes from low to high. The writing to the register is only enabled if exactly 16 bits are transmitted within one transfer packet. If more or less clock pulses are counted within one packet the complete packet is ignored.

AMIS-30521 responds on every incoming byte by shifting out the data stored on the last address sent via the bus. After POR the initial address is unknown. The following examples illustrate communication sessions between the master and AMIS-30521:

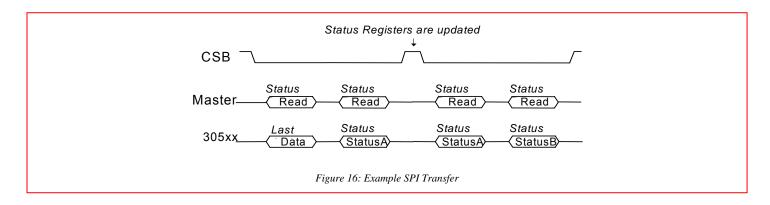


In this example, the master reads first the status from AddrA and then writes control byte in AddrB. After write operation the master could initiate a read back command in order to verify the data just written. Note that the first verification read operation returns the old content of AddrB, the second read command returns the new AddrB data.

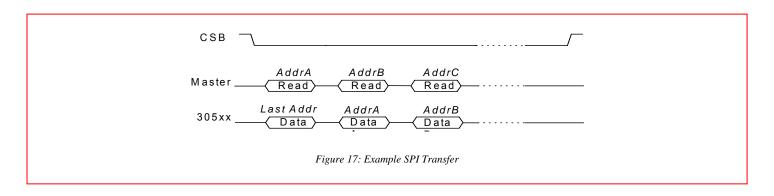
**Note:** The internal data out shift buffer of AMIS-30521 is updated with the content of the selected SPI register only at the last (every eighth) falling edge of the CLK signal (SPI Transfer Format and Pin Signals). As a result, new data for transmission cannot be written to the shift buffer at the beginning of the transfer packet and the first byte shifted out might represent old data.

This rule also applies when the master device wants to initiate an SPI transfer to read the status registers. Because the internal system clock updates the status registers only when CSB line is high, the first read out byte might represent an old status (see <u>Figure 16</u> and Figure 17 below).





The last case illustrates data polling from several registers of the SPI register bank:



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#### 9.3 SPI Control Registers

All SPI control registers have Read/Write access and default to "0" after power-on or hard reset.

Table 13: SPI Control Register 0

| Control Reg | Control Register 0 (CR0) |           |       |       |        |       |       |       |       |
|-------------|--------------------------|-----------|-------|-------|--------|-------|-------|-------|-------|
| Address     | Content                  | Structure |       |       |        |       |       |       |       |
|             | Content                  | Bit 7     | Bit 6 | Bit 5 | Bit 4  | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
| 01h         | Access                   | R/W       | R/W   | R/W   | R/W    | R/W   | R/W   | R/W   | R/W   |
| VIII        | Reset                    | 0         | 0     | 0     | 0      | 0     | 0     | 0     | 0     |
|             | Data                     | SM[2:0    | ]     |       | CUR[4: | 0]    |       |       |       |

Where:

R/W Read and Write access

Reset: Status after power-On or hard reset

SM[2:0]: Step mode Current amplitude

Table 14: SPI Control Register 1

|                   | Control Register 1 (CR1) |         |       |       |       |       |       |       |       |
|-------------------|--------------------------|---------|-------|-------|-------|-------|-------|-------|-------|
| Address Structure |                          |         |       |       |       |       |       |       |       |
|                   | Content                  | Bit 7   | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
| 02h               | Access                   | R/W     | R/W   | R/W   | R/W   | R/W   | R/W   | R/W   | R/W   |
| UZN               | Reset                    | 0       | 0     | 0     | 0     | 0     | 0     | 0     | 0     |
|                   | Data                     | DIRCTRL | NXTP  | -     | _     | PWMF  | PWMJ  | EMC[  | 1:0]  |

Where:

R/W Read and Write access

Reset:: Status after power-on or hard reset

DIRCTRL Direction control
NXTP NEXT polarity
PWMF PWM frequency
PWMJ PWM jitter

EMC [1:0] EMC slope control

Table 15: SPI Control Register 2

| V۷      | w.DataSheet4U.com Control Register 2 (CR2) |         |           |       |       |       |       |       |       |       |
|---------|--|---------|-----------|-------|-------|-------|-------|-------|-------|-------|
| Address |  |         | Structure |       |       |       |       |       |       |       |
|         |  | Content | Bit 7     | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|         | 026  | Access  | R/W       | R/W   | R/W   | R/W   | R/W   | R/W   | R/W   | R/W   |
|         | 03h  | Reset   | 0         | 0     | 0     | 0     | 0     | 0     | 0     | 0     |
|         |  | Data    | MOTEN     | SLP   | SLAG  | SLAT  | -     | -     | -     | -     |

Where:

R/W Read and Write access

Reset: Status after power-On or hard reset

MOTEN Motor enable

SLP Sleep

SLAG Speed load angle gain

SLAT Speed load angle transparency

Table 16: SPI Control Parameter Overview SLAT

| Symbol | Description                           | Status                     | Behavior               |
|--------|---------------------------------------|----------------------------|------------------------|
| CLAT   | Crossil and Aprila Transporters white | <SLAT $>$ = $0$            | SLA is transparent     |
| SLAT   | Speed Load Angle Transparency bit     | $\langle SLAT \rangle = 1$ | SLA is NOT transparent |



Table 17: SPI Control Parameter Overview SLAG

| Symbol | Description                   | Status                     | Value       |
|--------|-------------------------------|----------------------------|-------------|
| SLAC   | Speed Load Apple Cain patting | <SLAG $>$ = $0$            | Gain = 0.5  |
| SLAG   | Speed Load Angle Gain setting | $\langle SLAG \rangle = 1$ | Gain = 0.25 |

Table 18: SPI Control Parameter Overview PWMF

| Symbol  | Description                              | Status            | Value               |
|---------|--|-------------------|---------------------|
| PWMF    | Enables doubling of the PWM frequency    | <PWMF $>$ = $0$   | $f_{PWM} = 22.8kHz$ |
| FVVIVIF | Enables doubling of the Pyvivi frequency | <pwmf> = 1</pwmf> | $f_{PWM} = 45.6kHz$ |

Table 19: SPI Control Parameter Overview PWMJ

| Symbol  | Description         | Status            | Behavior        |
|---------|---------------------|-------------------|-----------------|
| PWMJ    | Enables jittery PWM | <PWMJ $>$ = $0$   | Jitter disabled |
| FVVIVIJ |                     | <pwmj> = 1</pwmj> | Jitter enabled  |

Table 20: SPI Control Parameter Overview SLP

| Symbol | Description        | Status                    | Behavior    |
|--------|--------------------|---------------------------|-------------|
| CI D   | Fuchles also mode  | $\langle SLP \rangle = 0$ | Active mode |
| SLP    | Enables sleep mode | $\langle SLP \rangle = 1$ | Sleep mode  |

Table 21: SPI Control Parameter Overview MOTEN

| Symbol   | Description                        | Status           | Value            |
|----------|------------------------------------|------------------|------------------|
| MOTEN    | Activates the motor driver outputs | <MOTEN $>$ = $0$ | Drivers disabled |
| IVIOTEIN | Activates the motor driver outputs | < MOTEN > = 1    | Drivers enabled  |

Table 22: SPI Control Parameter Overview DIRCTRL

| Symbol  | Description                                    | Status          |                         | Value      |
|---------|--|-----------------|-------------------------|------------|
|         |  | <dir> = 0</dir> | <DIRCTRL $>$ = $0$      | CW motion  |
| DIDCTDI | Controls the direction of rotation             | <dir> - 0</dir> | <dirctrl> = 1</dirctrl> | CCW motion |
| DIRCTRL | (in combination with logic level on input DIR) | <dir> = 1</dir> | <DIRCTRL $>$ = $0$      | CCW motion |
|         |  | <dik> - I</dik> | <dirctrl> = 1</dirctrl> | CW motion  |

Table 23: SPI Control Parameter Overview NXTP

| Symbol | Description                                       | Status          | Value                   |
|--------|---|-----------------|-------------------------|
| NXTP   | Sologto if NVT triggers on riging or falling odge | <NXTP $>$ = $0$ | Trigger on rising edge  |
| INATE  | Selects if NXT triggers on rising or falling edge | <NXTP $> = 1$   | Trigger on falling edge |

CUR [4:0] Selects IMCmax peak. This is the peak or amplitude of the regulated current waveform in the motor coils.

Table 24: SPI Control Parameter Overview CUR[4:0]

| 1 abic 24. C | 1 1 001 |   |       |    | CIVICA | / CON[4.0]   |       |   |   |       |    |   |              |
|--------------|---------|---|-------|----|--------|--------------|-------|---|---|-------|----|---|--------------|
| Index        |         | С | UR[4: | 0] |        | Current (mA) | Index |   | C | UR[4: | 0] |   | Current (mA) |
| 0            | 0       | 0 | 0     | 0  | 0      | 30           | 10    | 1 | 0 | 0     | 0  | 0 | 365          |
| 1            | 0       | 0 | 0     | 0  | 1      | 60           | 11    | 1 | 0 | 0     | 0  | 1 | 400          |
| 2            | 0       | 0 | 0     | 1  | 0      | 90           | 12    | 1 | 0 | 0     | 1  | 0 | 440          |
| 3            | 0       | 0 | 0     | 1  | 1      | 100          | 13    | 1 | 0 | 0     | 1  | 1 | 485          |
| 4            | 0       | 0 | 1     | 0  | 0      | 110          | 14    | 1 | 0 | 1     | 0  | 0 | 535          |
| 5            | 0       | 0 | 1     | 0  | 1      | 120          | 15    | 1 | 0 | 1     | 0  | 1 | 595          |
| 6            | 0       | 0 | 1     | 1  | 0      | 135          | 16    | 1 | 0 | 1     | 1  | 0 | 650          |
| 7            | 0       | 0 | 1     | 1  | 1      | 150          | 17    | 1 | 0 | 1     | 1  | 1 | 725          |
| 8            | 0       | 1 | 0     | 0  | 0      | 160          | 18    | 1 | 1 | 0     | 0  | 0 | 800          |
| 9            | 0       | 1 | 0     | 0  | 1      | 180          | 19    | 1 | 1 | 0     | 0  | 1 | 885          |
| Α            | 0       | 1 | 0     | 1  | 0      | 200          | 1A    | 1 | 1 | 0     | 1  | 0 | 970          |
| В            | 0       | 1 | 0     | 1  | 1      | 220          | 1B    | 1 | 1 | 0     | 1  | 1 | 1070         |
| С            | 0       | 1 | 1     | 0  | 0      | 240          | 1C    | 1 | 1 | 1     | 0  | 0 | 1190         |
| D            | 0       | 1 | 1     | 0  | 1      | 270          | 1D    | 1 | 1 | 1     | 0  | 1 | 1300         |
| E            | 0       | 1 | 1     | 1  | 0      | 300          | 1E    | 1 | 1 | 1     | 1  | 0 | 1450         |
| F            | 0       | 1 | 1     | 1  | 1      | 325          | 1F    | 1 | 1 | 1     | 1  | 1 | 1600         |



EMC [1:0] Adjusts the dV/dt of the PWM voltage slopes on the motor pins.

Table 25: SPI Control Parameter Overview EMC[1:0]

| Index | EMC | [1:0] | Slope (V/μs) | Remark  |
|-------|-----|-------|--------------|---|
| 0     | 0   | 0     | 150          | Turn-on and turn-off voltage slope 10% to 90% |
| 1     | 0   | 1     | 100          | u   |
| 2     | 1   | 0     | 50           | и   |
| 3     | 1   | 1     | 25           | и   |

SM[2:0] Selects the micro-stepping mode.

Table 26: SPI Control Parameter Overview SM[2:0]

| Index | SM[2:0] |   |   | Step Mode                    | Remark                  |
|-------|---------|---|---|------------------------------|-------------------------|
| 0     | 0       | 0 | 0 | 1/32                         | Micro-step              |
| 1     | 0       | 0 | 1 | <sup>1</sup> / <sub>16</sub> | Micro-step              |
| 2     | 0       | 1 | 0 | <sup>1</sup> / <sub>8</sub>  | Micro-step              |
| 3     | 0       | 1 | 1 | 1/4                          | Micro-step              |
| 4     | 1       | 0 | 0 | 1/2                          | Uncompensated half-step |
| 5     | 1       | 0 | 1 | 1/2                          | Compensated half-step   |
| 6     | 1       | 1 | 0 | Full                         | Full step               |
| 7     | 1       | 1 | 1 | N/A                          | For future use          |

#### 9.4 SPI Status Register Description

All four SPI status registers have Read Access and are default to "0" after power-on or hard reset.

Table 27: SPI Status Register 0

|                   | Status Register 0 (SR0) |       |       |        |       |       |       |       |       |  |
|-------------------|-------------------------|-------|-------|--------|-------|-------|-------|-------|-------|--|
| Address Structure |                         |       |       |        |       |       |       |       |       |  |
|                   | Content                 | Bit 7 | Bit 6 | Bit 5  | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
| 0.415             | Access                  | R     | R     | R      | R     | R     | R     | R     | R     |  |
| <u>04h</u>        | Reset                   | 0     | 0     | 0      | 0     | 0     | 0     | 0     | 0     |  |
|                   | Data                    | PAR   | TW    | CPfail | -     | OPENX | OPENY | -     | -     |  |

Where:

R Read only mode access

Reset Status after power-pn or hard reset

PAR Parity check
www.lEwaSheet4U.coffhermal warning
Cpfail Charge pump failure
OPENX Open Coil X detected
OPENY Open Coil Y detected

Remark: Data is **not** latched

Table 28: SPI Status Register 1

|         | Status Register 1 (SR1) |       |        |        |        |        |       |       |       |  |
|---------|-------------------------|-------|--------|--------|--------|--------|-------|-------|-------|--|
| Address | ress Content Structure  |       |        |        |        |        |       |       |       |  |
|         | Content                 | Bit 7 | Bit 6  | Bit 5  | Bit 4  | Bit 3  | Bit 2 | Bit 1 | Bit 0 |  |
| OFh     | Access                  | R     | R      | R      | R      | R      | R     | R     | R     |  |
| 05h     | Reset                   | 0     | 0      | 0      | 0      | 0      | 0     | 0     | 0     |  |
|         | Data                    | PAR   | OVCXPT | OVCXPB | OVCXNT | OVCXNB | -     | -     | -     |  |

Where:

R Read only mode access

Reset Status after power-on or hard reset

PAR Parity check

OVXPT Over-current detected on X H-bridge: MOTXP terminal, top transistor
OVXPB Over-current detected on X H-bridge: MOTXP terminal, bottom transistor
OVXNT Over-current detected on X H-bridge: MOTXN terminal, top transistor
OVXNB Over-current detected on X H-bridge: MOTXN terminal, bottom transistor

Remark: Data is latched



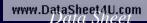


Table 29: SPI Status Register 2

|         | Status Register 2 (SR2) |       |           |        |         |        |       |       |       |  |  |
|---------|-------------------------|-------|-----------|--------|---------|--------|-------|-------|-------|--|--|
| Address | Content                 |       | Structure |        |         |        |       |       |       |  |  |
|         | Content                 | Bit 7 | Bit 6     | Bit 5  | Bit 4   | Bit 3  | Bit 2 | Bit 1 | Bit 0 |  |  |
| och     | Access                  | R     | R         | R      | R       | R      | R     | R     | R     |  |  |
| 06h     | Reset                   | 0     | 0         | 0      | 0       | 0      | 0     | 0     | 0     |  |  |
|         | Data                    | PAR   | OVCYPT    | OVCYPB | OVCYYNT | OVCYNB | TSD   | 1     | 1     |  |  |

Where:

R Read only mode access

Reset Status after power-on or hard reset

PAR Parity check

OVCYPT Over-current detected on Y H-bridge: MOTYP terminal, top transistor
OVCYPB Over-current detected on Y H-bridge: MOTYP terminal, bottom transistor
OVCYNT Over-current detected on Y H-bridge: MOTYN terminal, top transistor
OVCYNB Over-current detected on Y H-bridge: MOTYN terminal, bottom transistor

TSD Thermal shutdown

Remark: Data is latched

Table 30: SPI Status Register 3

|                             | Status Register 3 (SR3) |       |          |       |       |       |       |       |       |  |
|-----------------------------|-------------------------|-------|----------|-------|-------|-------|-------|-------|-------|--|
| Address Structure Structure |                         |       |          |       |       |       |       |       |       |  |
|                             | Content                 | Bit 7 | Bit 6    | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
| 076                         | Access                  | R     | R        | R     | R     | R     | R     | R     | R     |  |
| 07h                         | Reset                   | 0     | 0        | 0     | 0     | 0     | 0     | 0     | 0     |  |
|                             | Data                    | PAR   | MSP[6:0] |       |       |       |       |       |       |  |

Where:

R Read only mode access

Reset Status after power-pn or hard reset

PAR Parity check

MSP [6:0] Translator micro-step position

Remark: Data is **not** latched

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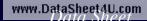


Table 31: SPI Status Flags Overview

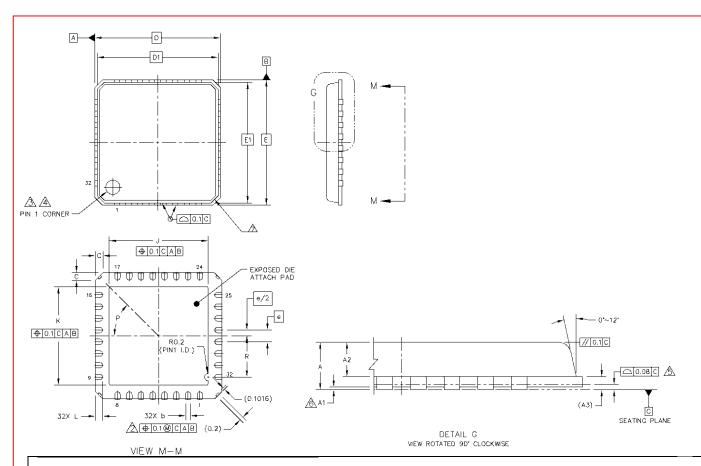
| Flag  | Mnemonic | Length<br>(bit) | Related SPI Register  | Comment  | Reset State |
|---|----------|-----------------|-----------------------|--|-------------|
| Charge pump failure   | CPFail   | 1               | SPI Status Register 0 | '0' = no failure '1' = failure: indicates that the charge pump does not reach the required voltage level. Note 1 | '0'         |
| Micro-step position   | MSP[6:0] | 7               | SPI Status Register 0 | Translator micro-step position   | '0000000'   |
| OPEN Coil X   | OPENX    | 1               | SPI Status Register 0 | '1' = Open coil detected   | <b>'0'</b>  |
| OPEN Coil Y   | OPENY    | 1               | SPI Status Register 0 | '1' = Open coil detected   | '0'         |
| OVer Current on X<br>H-bridge; MOTXN<br>terminal; Bottom tran.  | OVCXNB   | 1               | SPI Status Register 1 | '0' = no failure '1' = failure: indicates that over current is detected at bottom transistor XN-terminal         | ʻ0'         |
| OVer Current on X<br>H-bridge; MOTXN<br>terminal; Top transist. | OVCXNT   | 1               | SPI Status Register 1 | '0' = no failure '1' = failure: indicates that over current is detected at top transistor XN-terminal            | <b>'</b> 0' |
| OVer Current on X<br>H-bridge; MOTXP<br>terminal; Bottom tran.  | OVCXPB   | 1               | SPI Status Register 1 | '0' = no failure '1' = failure: indicates that over current is detected at bottom transistor XP-terminal         | '0'         |
| OVer Current on X<br>H-bridge; MOTXP<br>terminal; Top transist. | OVCXPT   | 1               | SPI Status Register 1 | '0' = no failure '1' = failure: indicates that over current is detected at top transistor XP-terminal            | '0'         |
| OVer Current on Y<br>H-bridge; MOTYN<br>terminal; Bottom tran.  | OVCYNB   | 1               | SPI Status Register 2 | '0' = no failure '1' = failure: indicates that over current is detected at bottom transistor YN-terminal         | '0'         |
| OVer Current on Y<br>H-bridge; MOTYN<br>terminal; Top transist. | OVCYNT   | 1               | SPI Status Register 2 | '0' = no failure '1' = failure: indicates that over current is detected at top transistor YN-terminal            | '0'         |
| OVer Current on Y<br>H-bridge; MOTYP<br>terminal; Bottom tran.  | OVCYPB   | 1               | SPI Status Register 2 | '0' = no failure '1' = failure: indicates that over current is detected at bottom transistor YP-terminal         | ʻ0'         |
| OVer Current on Y<br>H-bridge; MOTYP<br>terminal; Top transist. | OVCYPT   | 1               | SPI Status Register 2 | '0' = no failure '1' = failure: indicates that over current is detected at top transistor YP-terminal            |             |
| Thermal shutdown  | TSD      | 1               | SPI Status Register 2 |  | <b>'</b> 0' |
| Thermal warning   | TW       | 1               | SPI Status Register 0 |  | <b>'</b> 0' |

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### 10.0 Package Outline



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| □ a <u>D</u> amens | 2aumensions: OH |       |       |        |  |  |  |  |  |
|--------------------|-----------------|-------|-------|--------|--|--|--|--|--|
| Dim                | Min             | Nom   | Max   | Unit   |  |  |  |  |  |
| Α                  | 0.8             |       | 0.9   | mm     |  |  |  |  |  |
| A1                 | 0               | 0.02  | 0.05  | mm     |  |  |  |  |  |
| A2                 | 0.576           | 0.615 | 0.654 | mm     |  |  |  |  |  |
| A3                 |                 | 0.203 |       | mm     |  |  |  |  |  |
| b                  | 0.25            | 0.3   | 0.35  | mm     |  |  |  |  |  |
| С                  | 0.24            | 0.42  | 0.6   | mm     |  |  |  |  |  |
| D                  |                 | 7     |       | mm     |  |  |  |  |  |
| D1                 |                 | 6.75  |       | mm     |  |  |  |  |  |
| Е                  |                 | 7     |       | mm     |  |  |  |  |  |
| E1                 |                 | 6.75  |       | mm     |  |  |  |  |  |
| е                  |                 | 0.65  |       | mm     |  |  |  |  |  |
| J                  | 5.37            | 5.47  | 5.57  | mm     |  |  |  |  |  |
| K                  | 5.37            | 5.47  | 5.57  | mm     |  |  |  |  |  |
| L                  | 0.35            | 0.4   | 0.45  | mm     |  |  |  |  |  |
| Р                  |                 | 45    |       | Degree |  |  |  |  |  |
| R                  | 2.185           |       | 2.385 | mm     |  |  |  |  |  |

#### Notes:

Dimensions apply to plated terminal and are measured between 0.2 and 0.25 mm from terminal tip.

The pin #1 indication must be placed on the top surface of the package by using indentation mark or other feature of package body.

Exact shape and size of this feature is optional

Applied for exposed pad and terminals. Exclude embedding part of exposed pad from measuring.

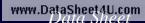
Applied only to terminals

Exact shape of each corner is optional

7x7 NQFP

Figure 18: NQFP-32: No Lead Quad Flat Pack; 32 Pins; Body Size 7x7mm (AMIS Reference: NQFP-32)





### 11.0 Soldering

#### 11.1 Introduction to Soldering Surface Mount Packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in the AMIS "Data Handbook IC26; Integrated Circuit Packages" (document order number 9398 652 90011). There is no soldering method that is ideal for all surface mount IC packages. Wave soldering is not always suitable for surface mount ICs, or for printed-circuit boards (PCB) with high population densities. In these situations re-flow soldering is often used.

#### 11.2 Re-flow Soldering

Re-flow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the PCB by screen printing, stencilling or pressure-syringe dispensing before package placement. Several methods exist for re-flowing; for example, infrared/convection heating in a conveyor type oven.

Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on the heating method. Typical reflow peak temperatures range from 215 to 260°C. The top-surface temperature of the packages should preferably be kept below 230°C.

#### 11.3 Wave Soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or PCBs with a high component density, as solder bridging and non-wetting can present major problems. To overcome these problems, the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
  - •Larger than or equal to 1.27mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the PCB;
  - •Smaller than 1.27mm, the footprint longitudinal axis must be parallel to the transport direction of the PCB. The footprint must incorporate solder thieves at the downstream end.
- For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the PCB. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured. Typical dwell time is four seconds at 250°C. A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

#### 11.4 Manual Soldering

wifix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300°C.

When using a dedicated tool, all other leads can be soldered in one operation within two to five seconds between 270 and 320°C.

Table 32: Soldering Process

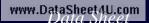
| Package                         | Soldering Method        |                        |  |  |  |  |
|---------------------------------|-------------------------|------------------------|--|--|--|--|
| гаскауе                         | Wave                    | Re-flow <sup>(1)</sup> |  |  |  |  |
| BGA, SQFP                       | Not suitable            | Suitable               |  |  |  |  |
| HLQFP, HSQFP, HSOP, HTSSOP, SMS | Not suitable (2)        | Suitable               |  |  |  |  |
| PLCC (3), SO, SOJ               | Suitable                | Suitable               |  |  |  |  |
| LQFP, QFP, TQFP                 | Not recommended (3) (4) | Suitable               |  |  |  |  |
| SSOP, TSSOP, VSO                | Not recommended (5)     | Suitable               |  |  |  |  |

#### Notes:

- (1) All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the drypack information in the "Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods."
- (2) These packages are not suitable for wave soldering as a solder joint between the PCB and heatsink (at bottom version) can not be achieved, and as solder may stick to the heatsink (on top version).
- (3) If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
- (4) Wave soldering is only suitable for LQFP, TQFP and QFP packages with a pitch (e) equal to or larger than 0.8mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65mm.
- (5) Wave soldering is only suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5mm.



# **AMIS-30521 Micro-stepping Motor Driver**



### 12.0 Company or Product Inquiries

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### 13.0 Document History

Table 33: Revision History

| able 66. Revision Filotory |           |  |  |  |  |  |
|----------------------------|-----------|--|--|--|--|--|
| Version                    | Date      | Modification   |  |  |  |  |
| 0.1                        | 18-jan-06 | initial draft  |  |  |  |  |
| 0.2                        | 24-jan-06 | draft : changed PWM description, added SLA pin description, changed POR and WD paragraphs.                       |  |  |  |  |
| 0.3                        | 9-feb-06  | CEN->CENB, NXT pin timing, SPI I/F, 30521 section 8.5, 8.6,8.7, 30522 section 8.4,8.5                            |  |  |  |  |
| 0.4                        | 9-mar-06  | updated pin-out & added drawing, CENB->CLR, ERR->ERRB, removed SWP bits, updated SPI bits, added package details |  |  |  |  |
| 0.5                        | 22-mar-06 | Renamed CS -> CSB, Swapped pins CLR and CSB  |  |  |  |  |
| 0.6                        | 24-may-06 | Updated pins, AC&DC tables, SLA specs, SM[2:0] decoding  |  |  |  |  |
| 1.0                        | 2-june-07 | Final version  |  |  |  |  |

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